

A

B

C

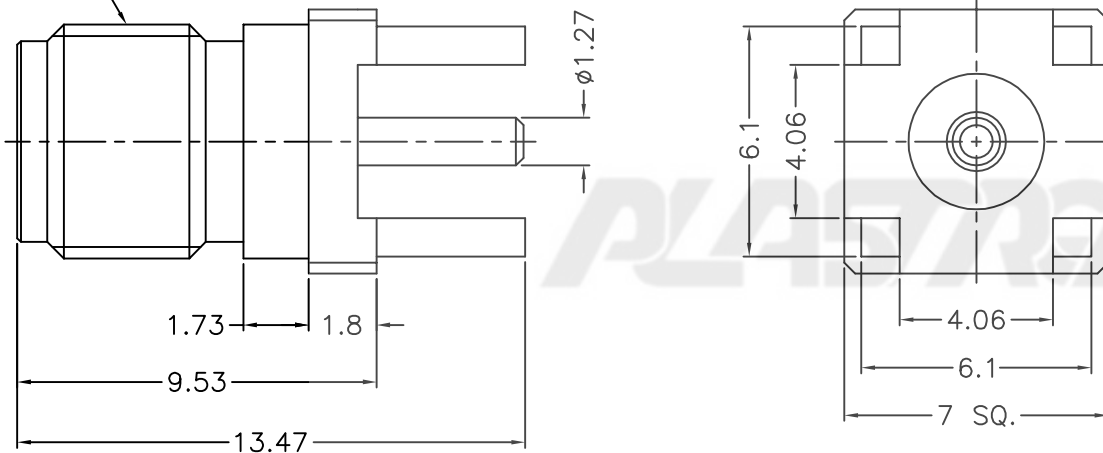
D

E

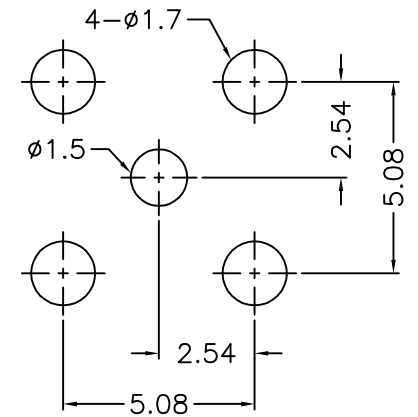
版次	ECN 编码	描述		设计/日期
1	EL24060030	初版发行		江蒙_2024/06/03
		改前	改后	

NOTES: FINISH(PLATING THICKNESS IN MICRO-INCHES)
 1.BRASS
 2.THIN GOLD OVER NICKEL PL.50 MIN.THICK OVER COPPER PL.50 MIN.THICK
 2.BERYLLIUM COPPER
 3.GOLD PL. 3 MIN.THICK OVER NICKEL PL.50 MIN.THICK OVER COPPER PL.50 MIN.THICK
 4.PTFE

1/4-36UNS-2A



JFCGBYBXX
 F:RF
 C:超小型
 G:SMA
 B:Beryllium Copper
 A: Gold Flash
 D:3u"
 G:10u"
 L:30u"
 B:Gold Plating



PCB MOUNTING HOLE

RoHS COMPLIANT



TOLERANCE TABLE	SCALE 2.5:1		DRAWN	江蒙	DATE	2024/06/03	DWG. NO. 600-0000-2475	TITLE SMA P.C.B. JACK CUSTOMER DRAWING	REV.	1
	X. ± 0.30	X.° ± 3°	UNIT	mm	CHECK	李晨涛			DATE	2024/06/03
	.X ± 0.25	.X° ± 2°	SIZE A4		APPROVE	朱宁静	DATE	2024/06/03	PARTS NO.(INTENDED USE) JFCGBYBXX	
	.XX ± 0.20									

A

B

C

D

E